

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HYEONG IL JEON	04/28/2014
HYUNG KOOK CHUNG	04/28/2014
HONG BAE KIM	04/28/2014
BYONG JIN KIM	04/28/2014
RECEIVING PARTY DATA	
Name:	AMKOR TECHNOLOGY, INC.
Street Address:	1900 S PRICE ROAD
City:	CHANDLER
State/Country:	ARIZONA
Postal Code:	85286
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14268877
CORRESPONDENCE DATA	
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Email:	kevinjacksonlaw@gmail.com
Correspondent Name:	LAW OFFICE OF KEVIN JACKSON
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Address Line 4:	PARADISE VALLEY, ARIZONA 85253
ATTORNEY DOCKET NUMBER:	JK-008
NAME OF SUBMITTER:	KEVIN B JACKSON
SIGNATURE:	/Kevin B Jackson/
DATE SIGNED:	05/15/2014
Total Attachments: 2	
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ASSIGNMENT & AGREEMENT

JK-008
Application No. 14/268,877

For good and valuable consideration, the receipt of which is hereby acknowledged, we,

Hyeong Il Jeon	of Gyeonggi-do, Republic of Korea
Hyung Kook Chang	of Seoul, Republic of Korea
Hong Bae Kim	of Seoul, Republic of Korea
Byoung Jit Kim	of Gyeonggi-do, Republic of Korea

have sold, assigned, and transferred, and do hereby sell, assign, and transfer unto Amkor Technology, Inc. (AMKOR) a Delaware corporation, having place of business at 1900 S. Price Road, City of Chandler, State of Arizona, United States of America, and its successors, assigns, and legal representatives, the entire right, title, and interest in and to certain inventions relating to improvements in

MICRO LEAD FRAME STRUCTURE HAVING REINFORCING PORTIONS AND METHOD

Attorney Docket No. JK-008; Amkor Ref: 1403009-P201403-002US described, illustrated, and claimed in Application No. 14/268,877 for Letters Patent of the United States of America executed by us and filed on May 2, 2014, together with the entire right, title and interest in and to the application, and in and to Letters Patent which may be issued upon the application, and upon any division, extension, continuation, or reissue thereof.

We hereby also sell, assign, and transfer unto AMKOR, the entire right, title, and interest in and to the invention and in and to applications for Letters Patent therefor in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of the inventions and the applications for Letters Patent in foreign countries, and we further authorize AMKOR to apply for Letters Patent in foreign countries directly in its own name, and to claim the priority of the filing date of the application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

We hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America to issue Letters Patent upon the aforesaid application, division, extension, continuation, or reissue, to AMKOR, for the sole use and behalf of AMKOR, its successors, assigns, and legal representatives, to the full end of the term for which the Letters Patent may be granted, the same as they would have been held and enjoyed by us had this assignment not been made, and we hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to AMKOR.

We agree that, when requested, we will, without charge to AMKOR, but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable, or convenient for securing and maintaining patents for the inventions in any and all countries and for vesting title thereto in AMKOR, its successors, assigns, and legal representatives or nominees.

We covenant with AMKOR, its successors, assigns, and legal representatives that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license, or other encumbrance.

Executed this 28 day of April, 2014

Hyeong Il Jeon
(Full Name)

Witnessed by:

Signature

April 28, 2014

Date

Dohyun No

Printed Name

ASSIGNMENT & AGREEMENT

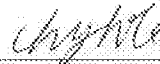
JK-008

Application No. 14/268,877

Amkor Ref: 1403009-P201403-002US

Assignment & Agreement (Continued)

Executed this 28 day of April, 2014



Hyung Kook Chung
(Full Name)

Witnessed by:



Signature

APR 28, 2014

Date

Dohyun Na

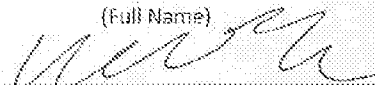
Printed Name

Executed this 28 day of Apr, 2014



Hong Bae Kim
(Full Name)

Witnessed by:



Signature

28 APR. 2014

Date

DOHYUN NA

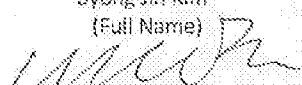
Printed Name

Executed this 28 day of APRIL, 2014



Byong Jiri Kim
(Full Name)

Witnessed by:



Signature

28 April, 2014

Date

Dohyun Na

Printed Name